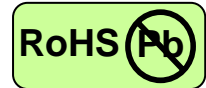


1.25 Gigabit Ethernet-Multimode Transceiver



SFP, Duplex LC Connector, 1310nm FP LD for Multimode Fiber, RoHS Compliant
Digital Diagnostics Functions



Features

- 1310nm FP LD
- Data Rate: 1.25Gbps, NRZ
- Single +3.3V Power Supply
- RoHS Compliant and Lead-free
- AC/AC Differential Electrical Interface
- Compliant with Multi-Source Agreement (MSA) Small Form Factor Pluggable (SFP)
- Compliant with SFF-8472 Digital Diagnostic Monitoring Interface
- Duplex LC Connector
- Compliance with specifications for IEEE-802.3z Gigabit Ethernet at 1.25 Gbps
- Compliance with ANSI specifications for Fibre Channel applications at 1.06 Gbps
- Eye Safety
Designed to meet Laser Class 1 comply with EN60825-1

Applications

- Gigabit Ethernet Links
- Fibre Channel Links at 1.06 Gbps
- High Speed Backplane Interconnects
- Switched Backbones

Description

The CT-1250TSP-MB2L-E from Coretek Opto Corp. is the high performance and cost-effective module for serial optical data communication applications specified for multimode of 1.25 Gb/s. It operates with +3.3V power supply. The module is intended for 50/125 μ m multimode fiber, operates at a nominal wavelength of 1310nm and complies with Multi-Source Agreement (MSA) Small Form Factor Pluggable (SFP). Each module is integrated digital diagnostics functions via an I²C serial interface.

The module is a duplex LC connector transceiver designed for use in Gigabit Ethernet applications and to provide IEEE-802.3z compliant link for 1.25Gb/s intermediate reach applications. The characteristics are performed in accordance with Telcordia Specification GR-468-CORE.

EMC

Most equipment utilizing high-speed transceivers will be required to meet the following requirements:

- 1) FCC in the United States
- 2) CENELEC EN55022 (CISPR 22) in Europe

To assist the customer in managing the overall equipment EMC performance, the transceivers have been designed to satisfy FCC class B limits and provide good immunity to radio-frequency electromagnetic fields.

Eye Safety

The transceivers have been designed to meet Class 1 eye safety and comply with EN 60825-1.

1.25 Gigabit Ethernet-Multimode Transceiver



Product Information

Model Number	Operating Voltage & SD Output	Distance	LD Type & Wavelength	Output Power	Sensitivity
CT-1250TSP-MB2L-E	3.3V TTL AC/AC	2 km	1310 nm FP	-9.5 ~ -3 dBm	≤-23 dBm

ABSOLUTE MAX RATINGS

PARAMETER	SYMBOL	MIN	MAX	UNIT	NOTE
Storage Temperature	T _S	-40	85	°C	
Supply Voltage	V _{CC}	0	6	V	
Data Input Voltage	---	0	V _{CC}	V	
Supply Current	I _S		300	mA	

OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Case Operating Temperature	T _A	-40		85	°C	
Supply Voltage	V _{CC}	3.1		3.5	V	
Data Input Voltage Swing	V _{ID}	300		1860	mV	

ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	MAX	UNIT	NOTE
Transmitter					
Transmitter Supply Current	I _{CCT}		200	mA	
Tx_Disable Input Voltage - Low	V _{IL}	0	0.8	V	
Tx_Disable Input Voltage - High	V _{IH}	2.0	V _{CC}	V	
Tx_Fault Output Voltage - Low	V _{OL}	0	0.8	V	
Tx_Fault Output Voltage - High	V _{OH}	2.0	V _{CC}	V	
Receiver					
Receiver Supply Current	I _{CCR}		100	mA	
Receiver Data Output Differential Voltage	V _{OD}	0.4	1.3	V	
Rx_LOS Output Voltage - Low	V _{OL}	0	0.8	V	
Rx_LOS Output Voltage - High	V _{OH}	2.0	V _{CC}	V	
MOD_DEF (1) , MOD_DEF (2) - Low	V _{IL}	-0.6	V _{CC} × 0.3	V	
MOD_DEF (1) , MOD_DEF (2) - High	V _{IH}	V _{CC} × 0.7	V _{CC} + 0.5	V	

TRANSMITTER ELECTRO-OPTICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
Optical Output Power	P _O	-9.5		-3	dBm	1
Extinction Ratio	ER	9			dB	
Center Wavelength	λ _c	1270		1355	nm	
Spectral Width (RMS)	Δλ			4	nm	
RIN	RIN			-117	dB/Hz	
Optical Rise time (20%-80%)	t _r			260	ps	2
Optical Fall time (20%-80%)	t _f			260	ps	2
Output Eye		Compliant with IEEE802.3z/D5.0				

1.25 Gigabit Ethernet-Multimode Transceiver



RECEIVER ELECTRO-OPTICAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
Maximum Input Optical Power	P_{max}	-3			dBm	3
Minimum Input Optical Power	P_{min}			-23	dBm	3
Operating Wavelength	λ	1100		1600	nm	
Optical Return Loss	ORL	12			dB	
Receiver Electrical 3dB Upper Cutoff Frequency	---			1500	MHz	
LOS of Signal - Asserted	P_A	-35			dBm	
LOS of Signal - Deasserted	P_D			-23	dBm	
Loss of Signal -Hysterisis	$P_D - P_A$	0.5			dB	

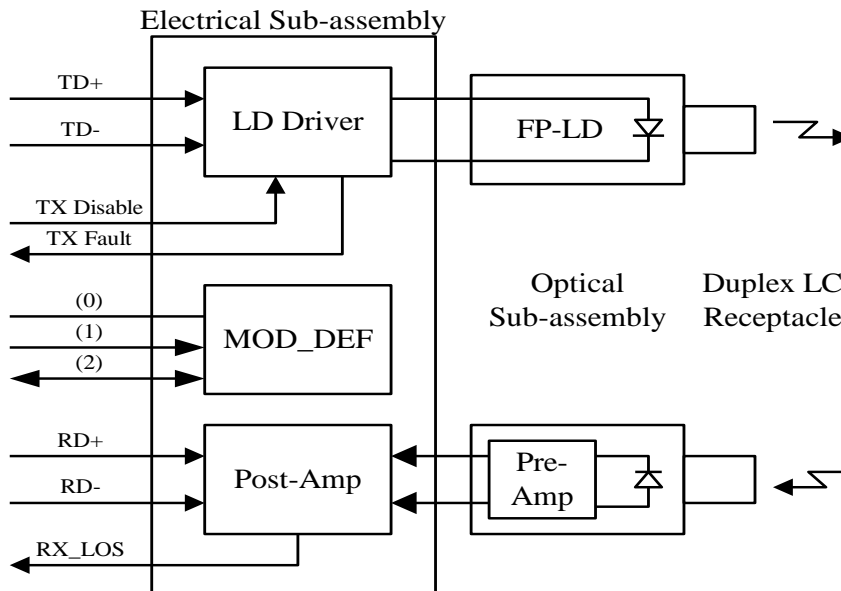
Notes:

1. Measured average power coupled into 50/125 μ m, 0.275 NA graded index multimode fiber.
2. These are 20-80% values.
3. Measured with 2^7-1 PRBS at BER< 10^{-12}

TIMING CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT	NOTE
TX_DISABLE Assert Time	t_{off}			10	μ s	
TX_DISABLE Negate Time	t_{on}			1	ms	
Time to initialize, include reset of TX_FAULT	t_{init}			300	ms	
TX_FAULT from fault to assertion	t_{fault}			100	μ s	
TX_DISABLE time to start reset	t_{reset}	10			μ s	
Receiver Loss of Signal Assert Time (off to on)	t_{A,RX_LOS}			100	μ s	
Receiver Loss of Signal Assert Time (on to off)	t_{D,RX_LOS}			100	μ s	

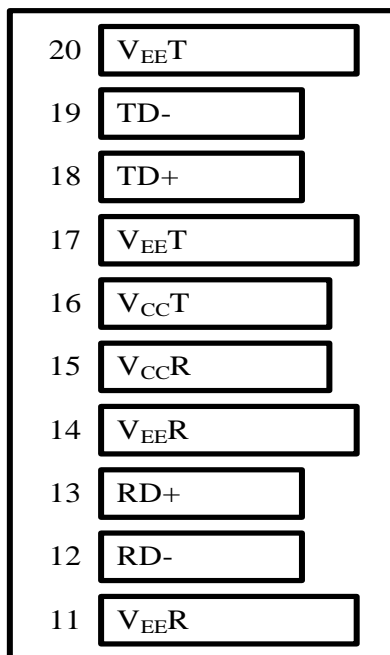
BLOCK DIAGRAM OF TRANSCEIVER



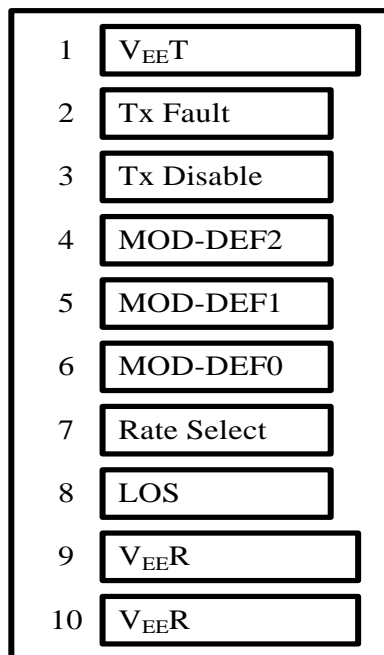
1.25 Gigabit Ethernet-Multimode Transceiver



PIN OUT DIAGRAM OF TRANSCEIVER



Top of Board



Bottom of Board (As Viewed through Top of Board)

PIN OUT TABLE

Pin	Symbol	Functional Description
1	VeeT	Transmitter Ground
2	TX Fault	Transmitter Fault Indication
3	TX Disable	Transmitter Disable – Module disables on high or open
4	MOD-DEF(2)	Module Definition 2 – Two wire serial ID interface
5	MOD-DEF(1)	Module Definition 1 – Two wire serial ID interface
6	MOD-DEF(0)	Module Definition 0 – Grounded in module
7	Rate Select	Not Connected
8	LOS	Loss of Signal
9	VeeR	Receiver Ground
10	VeeR	Receiver Ground
11	VeeR	Receiver Ground
12	RD-	Inverse Received Data Out
13	RD+	Received Data Out
14	VeeR	Receiver Ground
15	VccR	Receiver Power
16	VccT	Transmitter Power
17	VeeT	Transmitter Ground
18	TD+	Transmitter Data In
19	TD-	Inverse Transmitter Data In
20	VeeT	Transmitter Ground

1.25 Gigabit Ethernet-Multimode Transceiver



EEPROM Serial ID Memory Contents

Table 1 - EEPROM Serial ID Memory Contents (A0h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
00	1	Identifier	03	SFP
01	1	Ext. Identifier	04	MOD4
02	1	Connector	07	LC
03 ~ 10	8	Transceiver Codes	00 00 00 02 12 00 01 01	
11	1	Encoding	01	8B/10B
12	1	BR,nominal	0D	
13	1	Reserved	00	
14	1	Length (SMF)-km	00	0KM
15	1	Length (SMF)-100m	00	00m
16	1	Length (50um,OM2)	C8	2000m
17	1	Length (62.5um,OM1)	00	0m
18	1	Length (copper)	00	
19	1	Length (50um, OM3)	C8	2000m
20 ~ 35	16	Vendor Name	43 4F 52 45 54 45 4B 20 20 20 20 20 20 20 20 20	CORETEK
36	1	Unallocated	00	
37 ~ 39	3	OUI Code	00 00 00	
40 ~ 55	16	Vendor PN	43 54 2D 31 32 35 30 54 53 50 2D 4D 42 32 4C 45	CT-1250TSP-MB2LE
56 ~ 59	4	Vendor Rev	30 30 30 30	0001
60 ~ 61	2	Wavelength	05 1E	1310 nm
62	1	Reserved	00	
63	1	CC BASE	XX	Check sum
64 ~ 65	2	Options	00 1A	LOS,TX_FAULT and TX_DISABLE
66	1	BR max	00	
67	1	BR min	00	
68 ~ 83	16	Vendor SN	XX	
84 ~ 91	8	Date code		

1.25 Gigabit Ethernet-Multimode Transceiver



92	1	Diagnostic Monitoring Type	68	
93	1	Enhanced Options	90	
94	1	SFF-8472	01	Rev 9.3 of SFF-8472 Compliance
95	1	CC BASE	XX	Check sum
96 ~ 127	32	Vendor Specific		

Table 2- EEPROM Serial ID Memory Contents (A2h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
00 ~ 07	8	Temperature Alarm/Warning (°C)	6E 00 D8 00 64 00 DD 00	Alarm_H/L : 110/-40 Warning_H/L : 100/-35
08 ~ 15	8	Voltage Alarm/Warning (V)	8C A0 75 30 88 B8 79 18	Alarm_H/L : 3.6/3 Warning_H/L : 3.5/3.1
16 ~ 23	8	BiasCurrent Alarm/Warning (mA)	9C 40 03 E8 88 B8 07 D0	Alarm_H/L : 80/2 Warning_H/L : 70/4
24 ~ 31	8	Tx Power Alarm/Warning (dBm)	18 A6 03 7B 13 94 04 62	Alarm_H/L : -2/-10.50 Warning_H/L : -3/-9.50
32 ~ 39	8	Rx Power Alarm/Warning (dBm)	20 A5 00 27 13 94 00 32	Alarm_H/L : -2/-24 Warning_H/L : -3/-23

Table - Monitoring Specification

Parameter	Range	Accuracy	Calibration
Temperature	-40°C to 85°C	±3°C	Internal
Voltage	3.0 to 3.6V	±3%	Internal
Bias Current	0 to 100mA	±10%	Internal
TX Power	-9.5 to -3 dBm	±3dB	Internal
RX Power	-23 to -3 dBm	±3dB	Internal

Monitoring Specification

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X(A2h). Please see Figure 1. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table3.

**Figure 3.1: Digital Diagnostic Memory Map
Specific Data Field Descriptions**

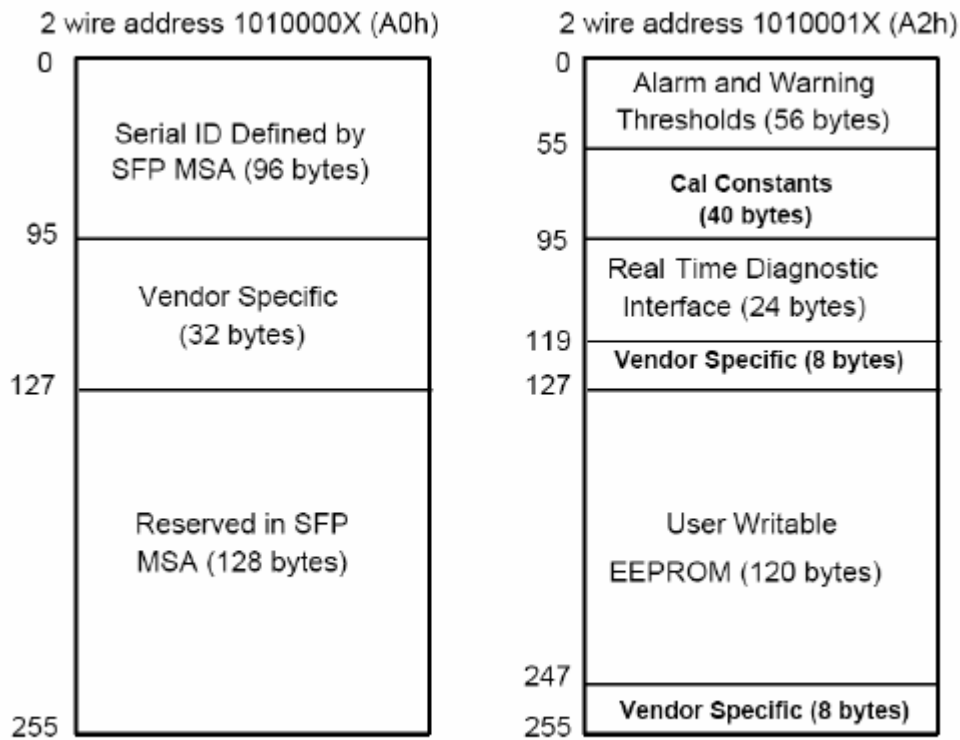
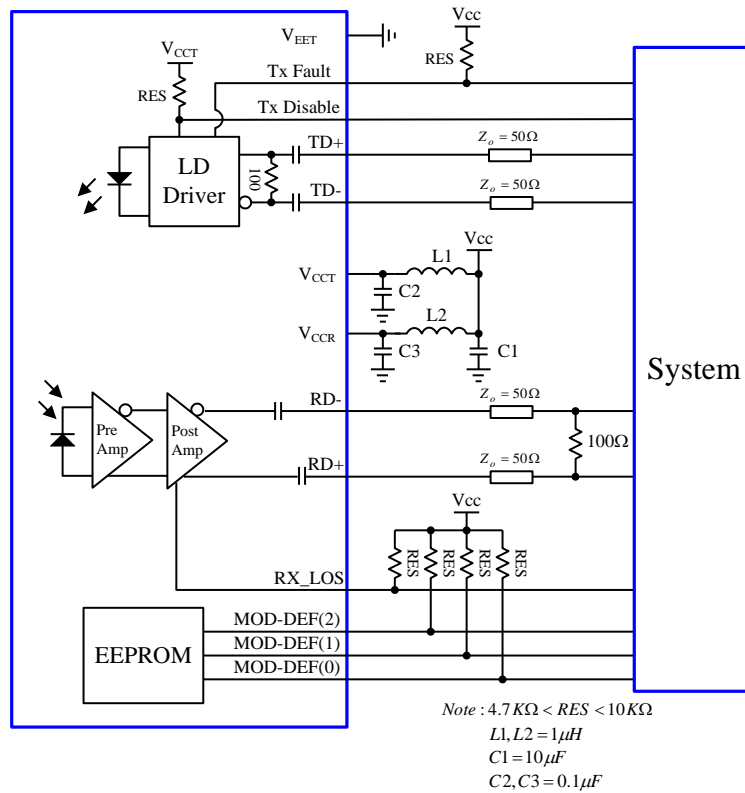


Figure 1, EEPROM Memory Map Specific Data Field Descriptions

1.25 Gigabit Ethernet-Multimode Transceiver

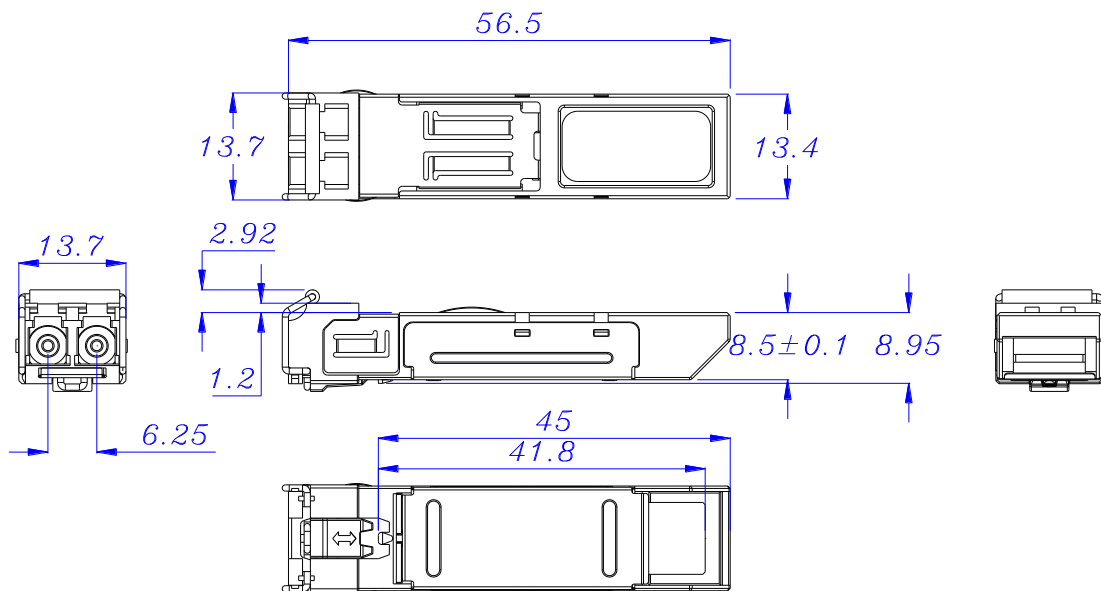


RECOMMENDED CIRCUIT SCHEMATIC



MECHANICAL DIMENSIONS

Units in mm



All dimensions are $\pm 0.2\text{mm}$ unless otherwise specified.

Claim:

CORETEK Opto Corp. reserves the right to make changes in the specification described hereinafter without prior notice.